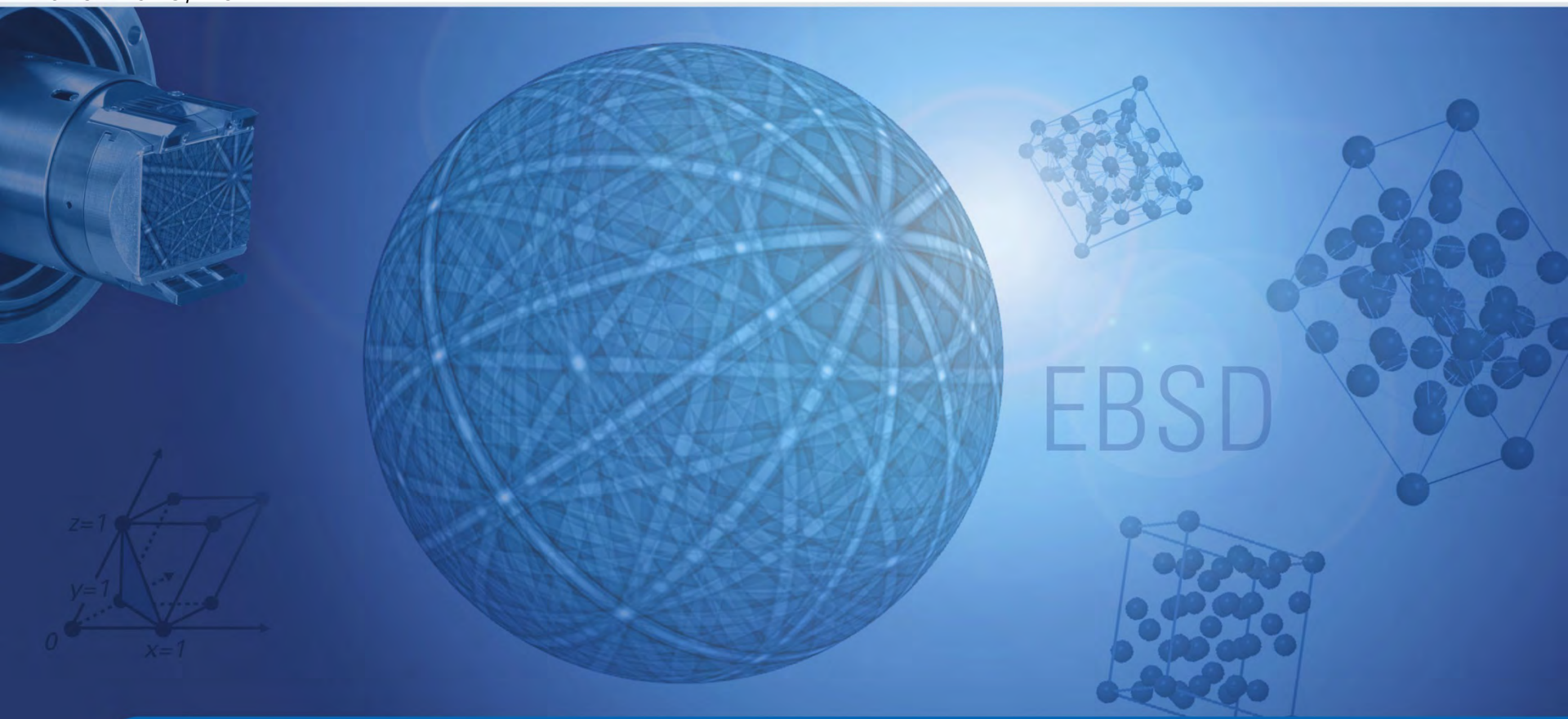


Quantitative Characterization of Nanostructured Materials with Fast TKD Measurement



Bruker Nano, Berlin





- **Dr. Daniel Goran**

Product Manager EBSD
Bruker Nano Analytics, Berlin, Germany

- **Dr. Laurie Palasse**

Senior Application Scientist EBSD
Bruker Nano Analytics, Berlin, Germany

High speed TKD in SEM

outline



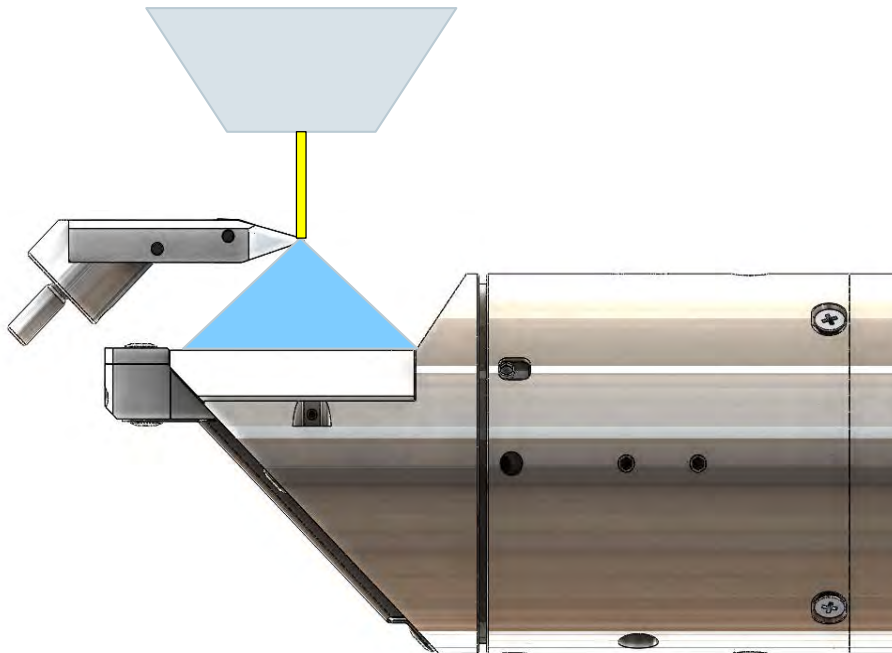
- Review of on-axis TKD geometry
- Application examples of fast-TKD: no compromise!
 - Speed
 - Spatial resolution
 - Indexing quality
 - Large area orientation mapping for statistics
- Combined EDS/TKD measurement

High speed TKD in SEM

Optimum sample-detector geometry



Schematic view



Strong signal

- Fast acquisition speeds
 - High efficiency
 - measurements less prone to beam instability
- low probe currents
 - Higher resolution
 - Low carbon contamination
- No pattern distortions
 - Pattern Center is in the middle
 - ⇔ almost no gnomonic projection induced distortions
 - ⇔ better band detection and indexing quality

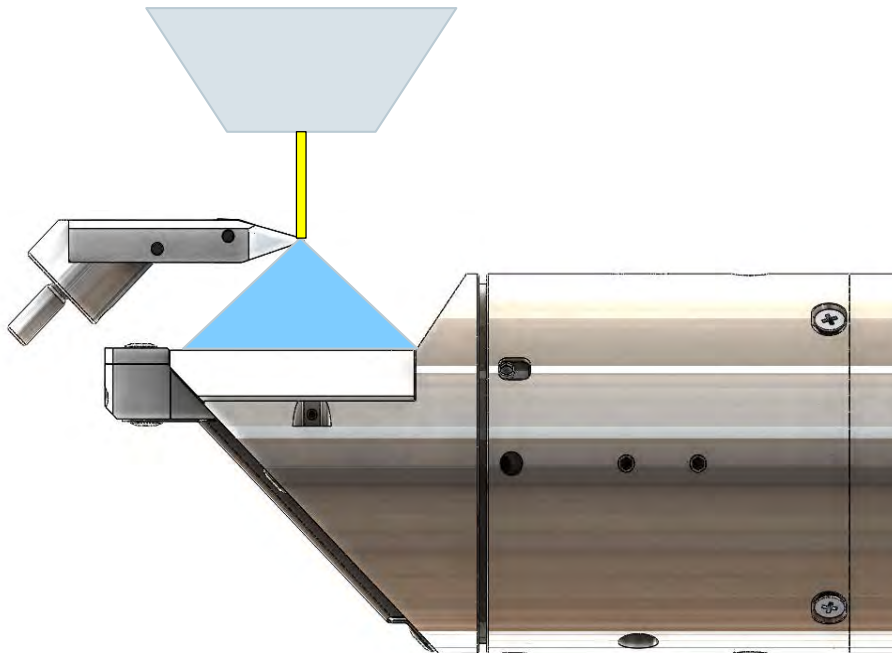
* LEM3, Metz, France "Orientation mapping by transmission-SEM with an on-axis detector",
J.-J Funderberger et al., Ultramicroscopy, 161, 17–22, 2016

High speed TKD in SEM

Optimum sample-detector geometry



Schematic view



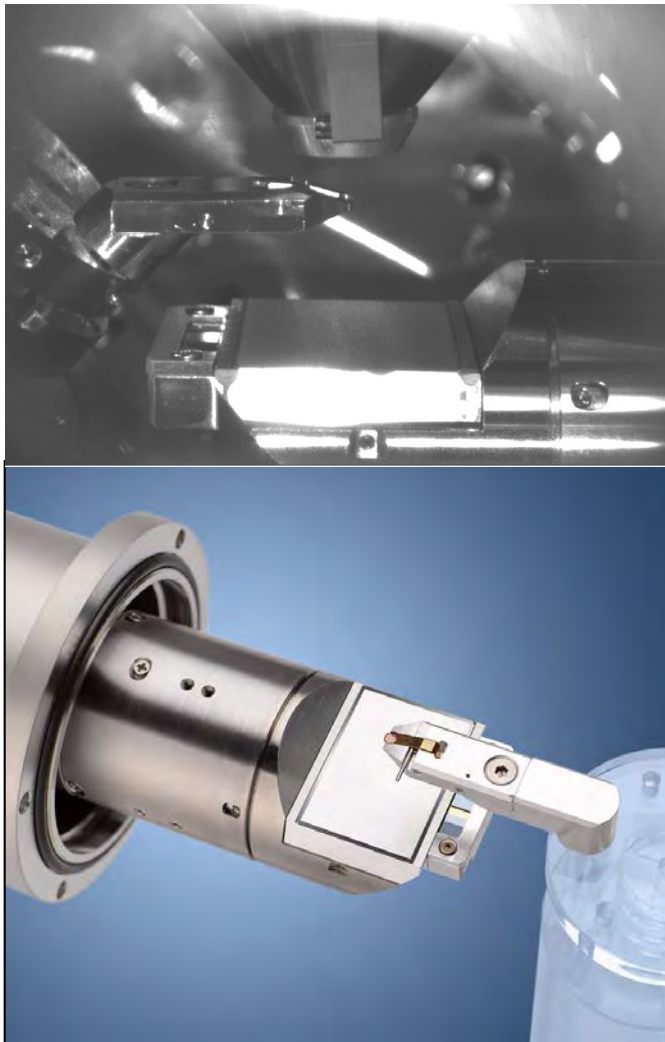
Strong signal

- Fast acquisition speeds
 - High efficiency
 - measurements less prone to beam instability
- low probe currents
 - Higher resolution
 - Low carbon contamination
- Flexibility in DD values
 - active area
 - Adjustment depending on atomic weight/thickness

* LEM3, Metz, France "Orientation mapping by transmission-SEM with an on-axis detector", J.-J Funderberger et al., Ultramicroscopy, 161, 17–22, 2016

High speed TKD in SEM

Optimum sample-detector geometry



OPTIMUS Main features:

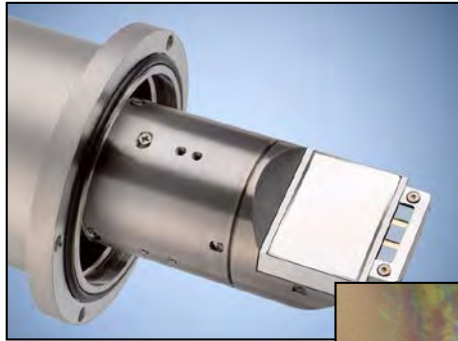
- Horizontal phosphor screen – for capturing the signal around SEM's optical axis
- DF/BF imaging (3x Si diodes)
- Easy to use/switch between EBSD and TKD modes
- Compatible with all existing e-Flash detectors

TKD sample holder

Patent EP 2824448A1

High speed TKD in SEM

Integrated ARGUS™ imaging system

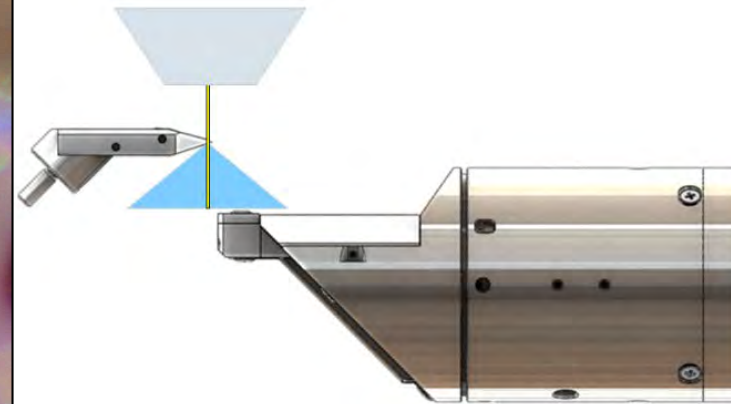
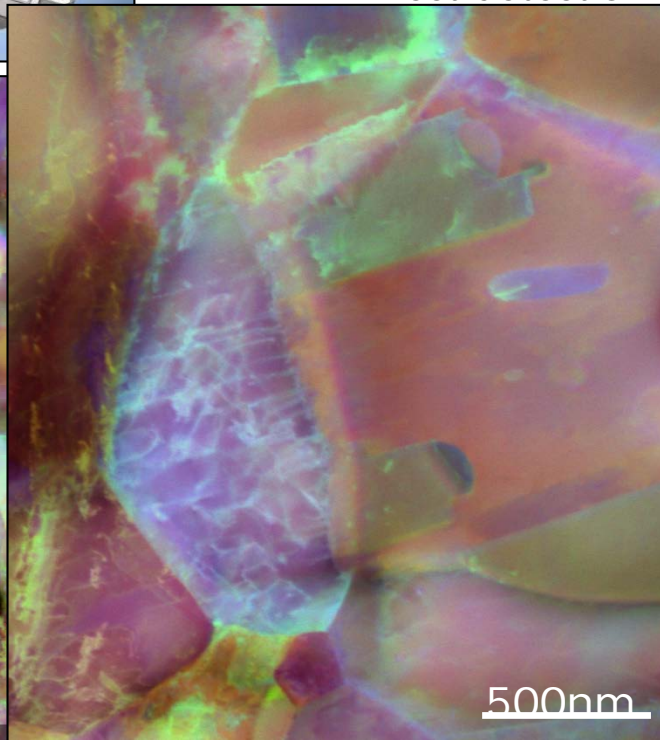
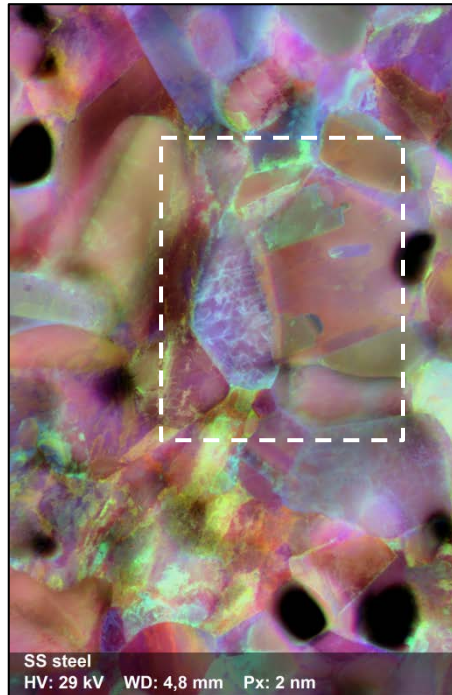


Feature:

- Built-in ARGUS™ imaging system (3x Si diodes)

Benefits:

- Color coded Dark Field imaging
- Direct detection – fast & sensitive (up to 125,000 p/s)



Thanks to Prof. Zeng Yi from Shanghai Institute of Ceramics in China for generously providing the sample

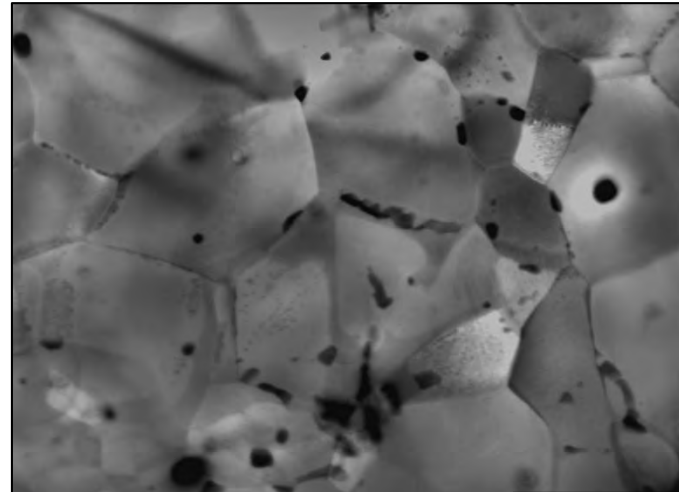
TKD in SEM using on-axis detector

Integrated ARGUS™ imaging system

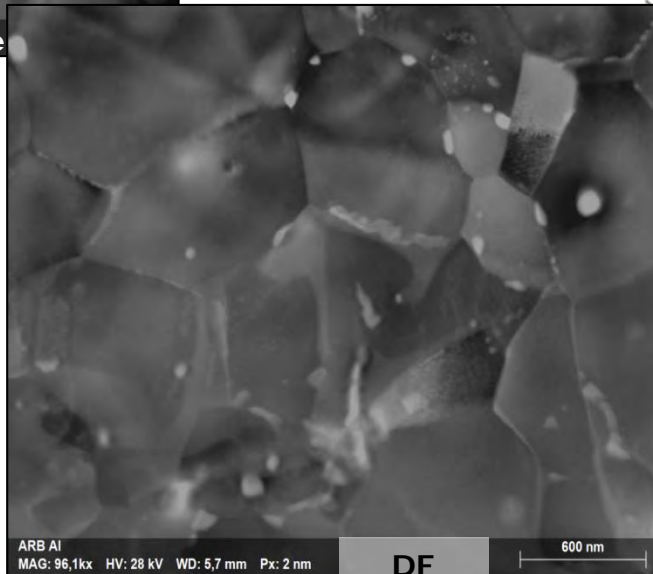


Benefits:

- Built-in BF/DF imaging system (3x Si diodes)
- Bright field imaging (middle diode)
- Dark field imaging (side diodes)

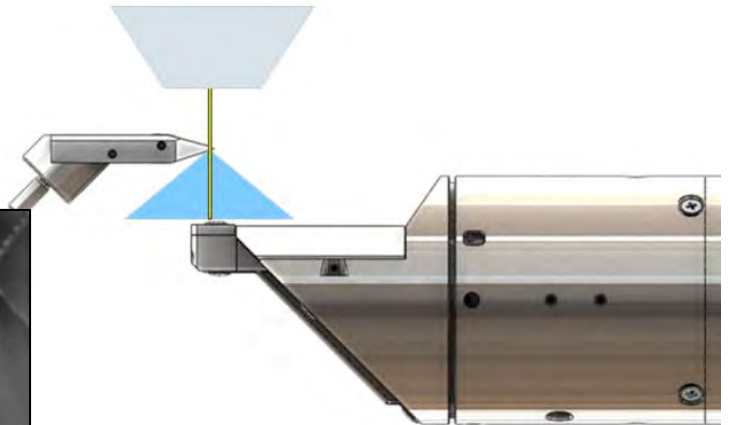


ARB AI
MAG: 96,1kx HV: 28 kV WD: 5,7 mm Px: 2 nm **BF image**



ARB AI
MAG: 96,1kx HV: 28 kV WD: 5,7 mm Px: 2 nm

DF
image



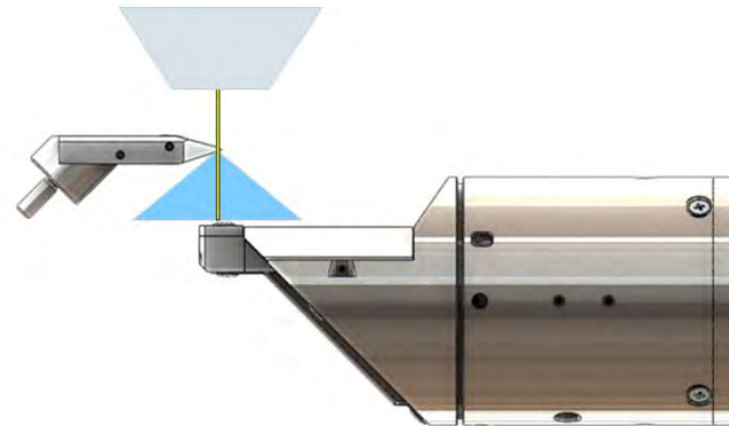
TKD in SEM using on-axis detector

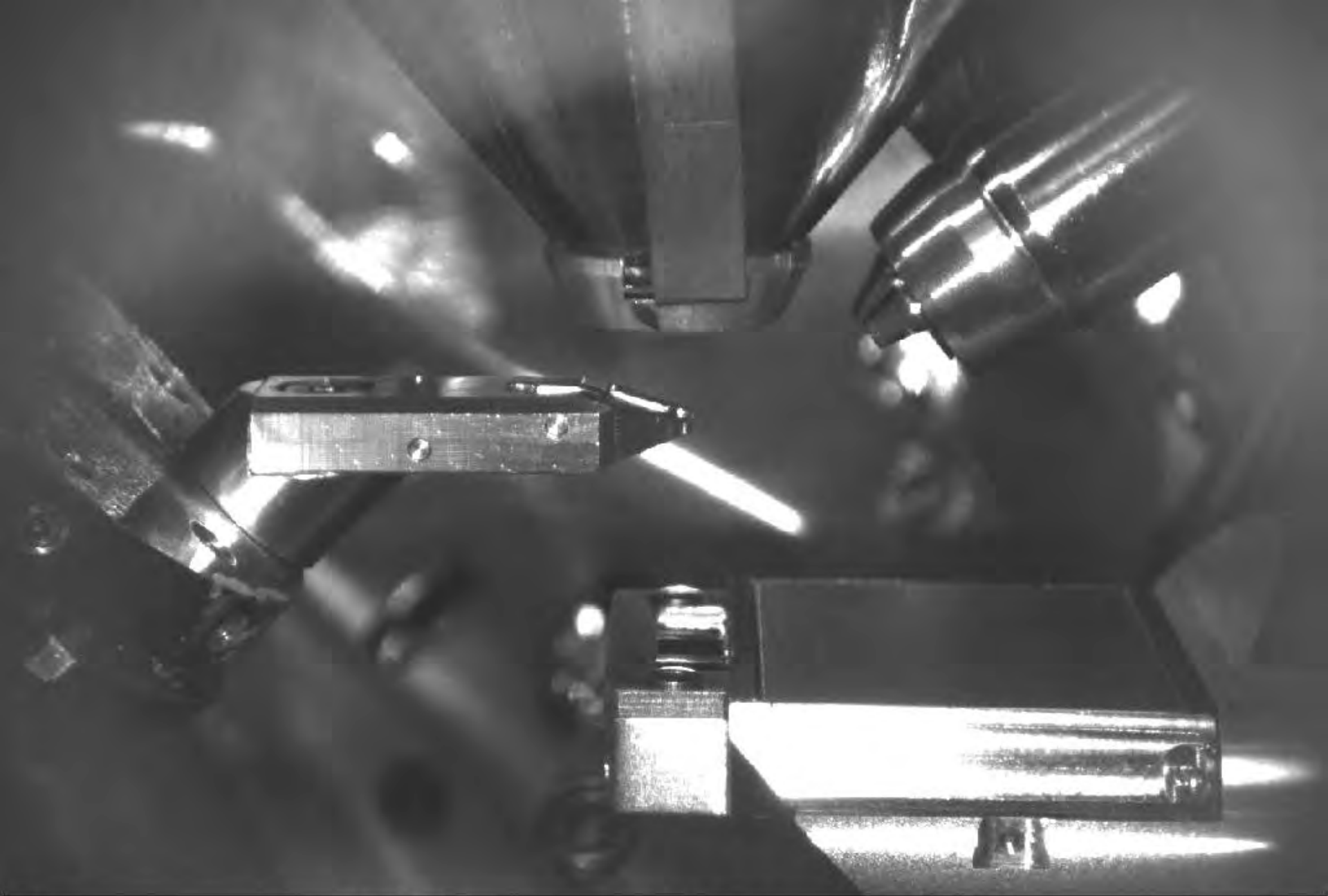
Integrated ARGUS™ imaging system



Benefits:

- Built-in BF/DF imaging system (3x Si diodes)





1 μm



EHT = 29.00 kV

WD = 7.1 mm

Signal A = USB TV2

Mag = 41.00 K X

Date :3 Dec 2015

Time :12:02:38



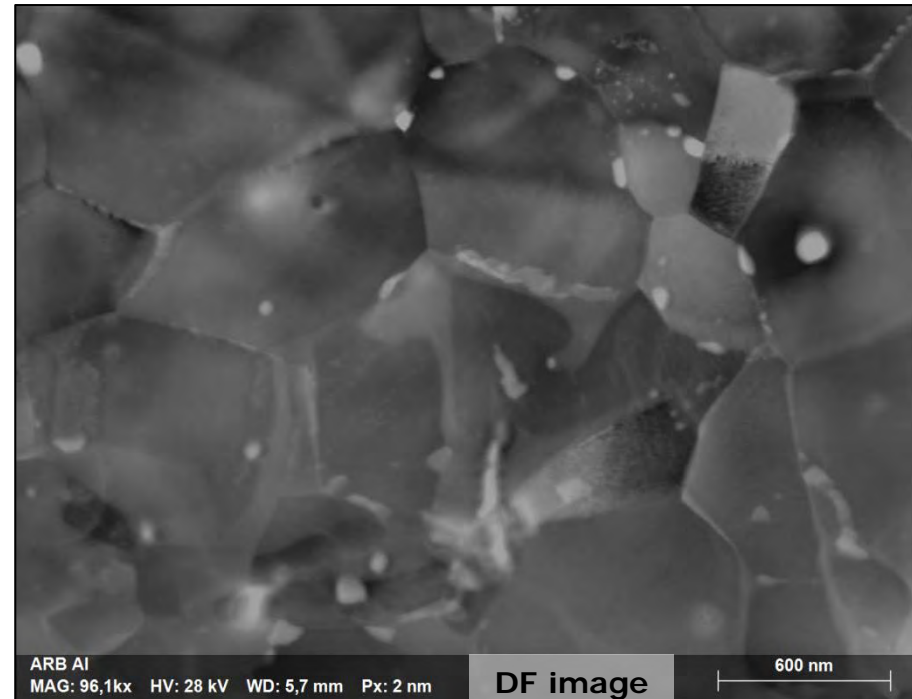
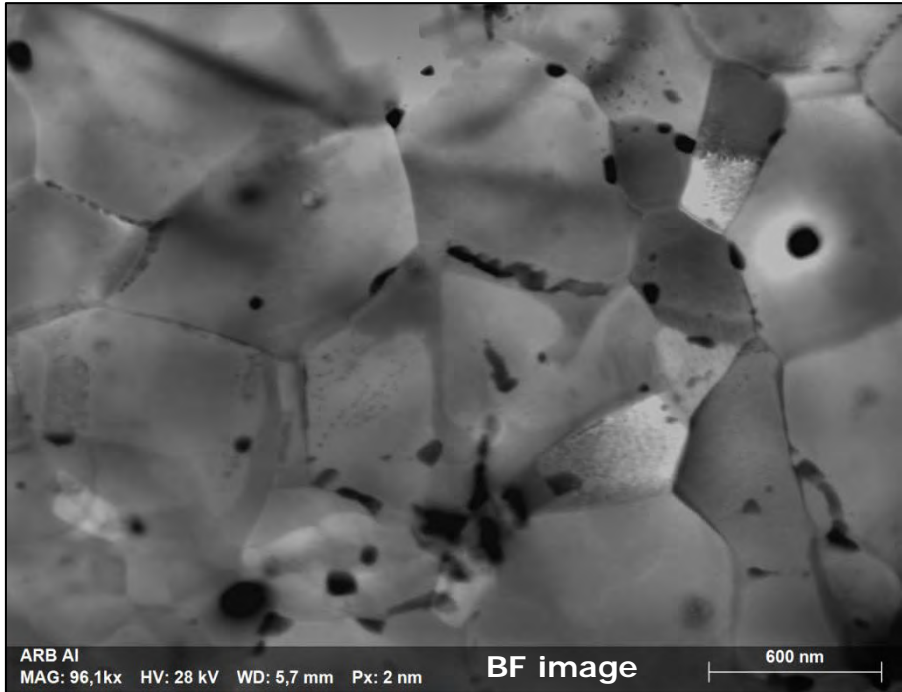
TKD in SEM using on-axis detector

Integrated ARGUS™ imaging system



Benefits:

- Built-in BF/DF imaging system (3x Si diodes)
- Bright field imaging (middle diode)
- Dark field imaging (side diodes)



High speed TKD in SEM Setup



- e-Flash^{FS} detector
- OPTIMUSTM TKD head
- Bruker TKD sample holder

Esprit 2.1 : all-in-one software

SW for all analytical techniques: WDS, μ XRF, EDS, EBSD, TKD, ...

For measurement and post-processing

High speed TKD in SEM

Application examples



large-area orientation mapping at nanoscale

High speed TKD in SEM

high speed measurement, moderate probe current



**Partially recrystallized
stainless steel**

Indexed points: 85.6%

Pattern resolution:

160x120

Speed: **623fps**

Probe current : **7nA**

Map size:

1990x1492pixels

Measurement time:

1:19:30h

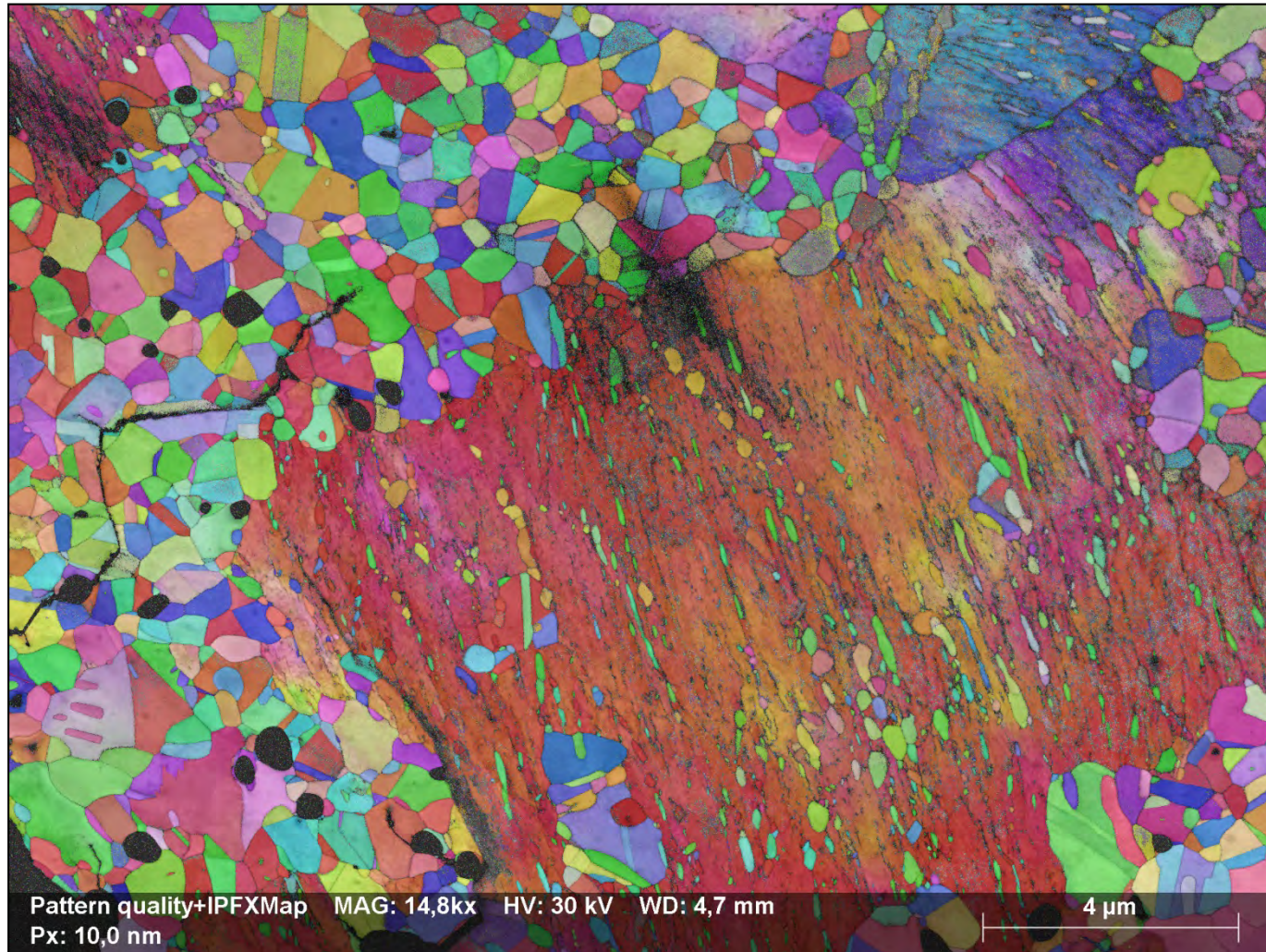
Step size: 10nm

Pattern quality MAG: 14,8kx HV: 30 kV WD: 4,7 mm Px: 10,0 nm

4 μ m

High speed TKD in SEM

high speed measurement, moderate probe current



Pattern quality+IPFXMap MAG: 14,8kx HV: 30 kV WD: 4,7 mm
Px: 10,0 nm

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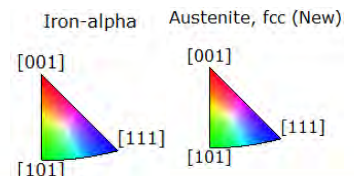
Map size:

1990x1492pixels

Measurement time:

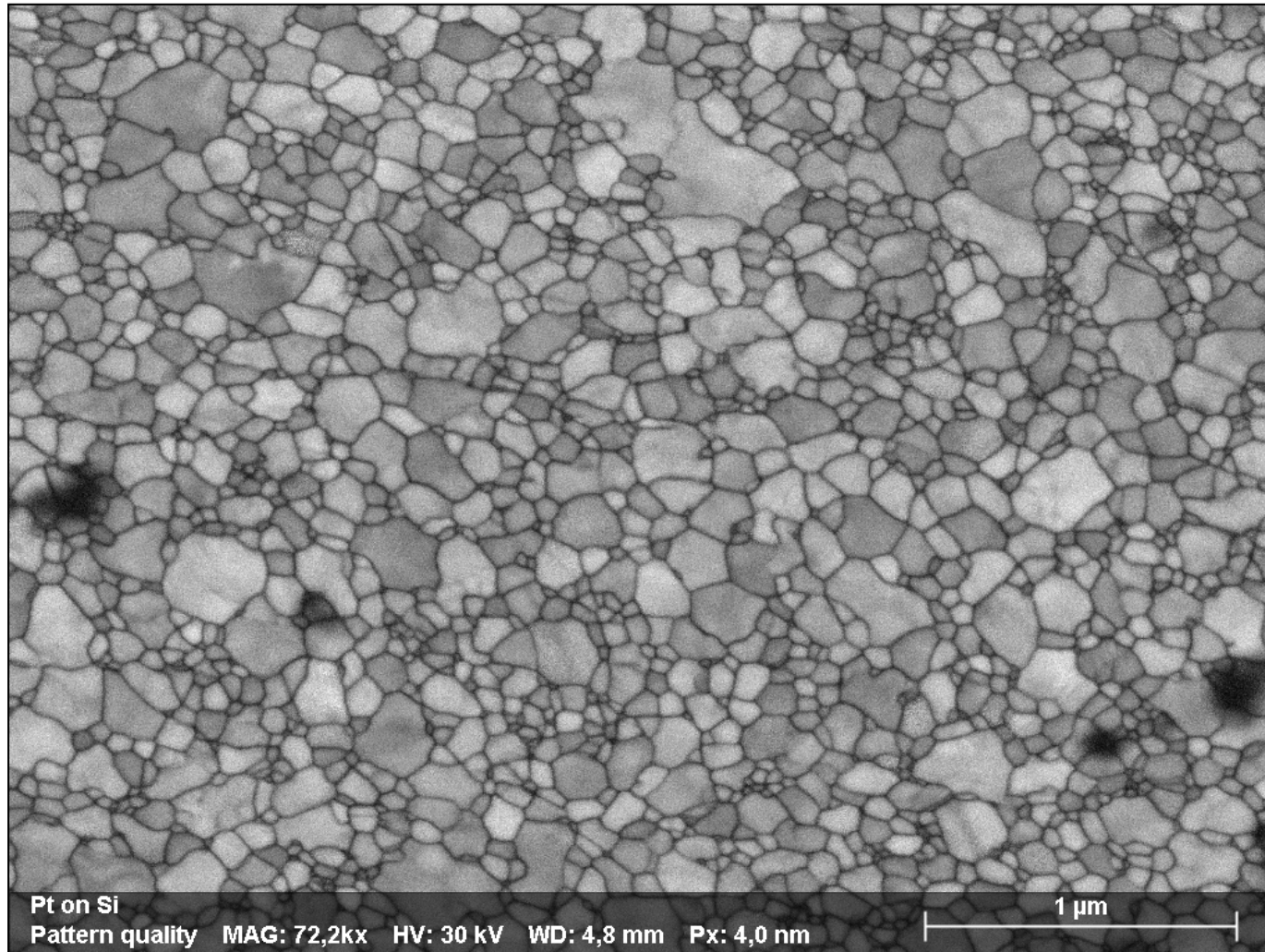
1:19:30h

Step size: 10nm



High speed TKD in SEM

higher spatial resolution, low probe current & speed



Pt thin film on Si

Indexed points: 93.1%

Pattern resolution:

160x120pixels

Speed: **328fps**

Probe current : 1,8 nA

Map size:

1017x763pixels

Measurement time:

39:27min

1260 grains

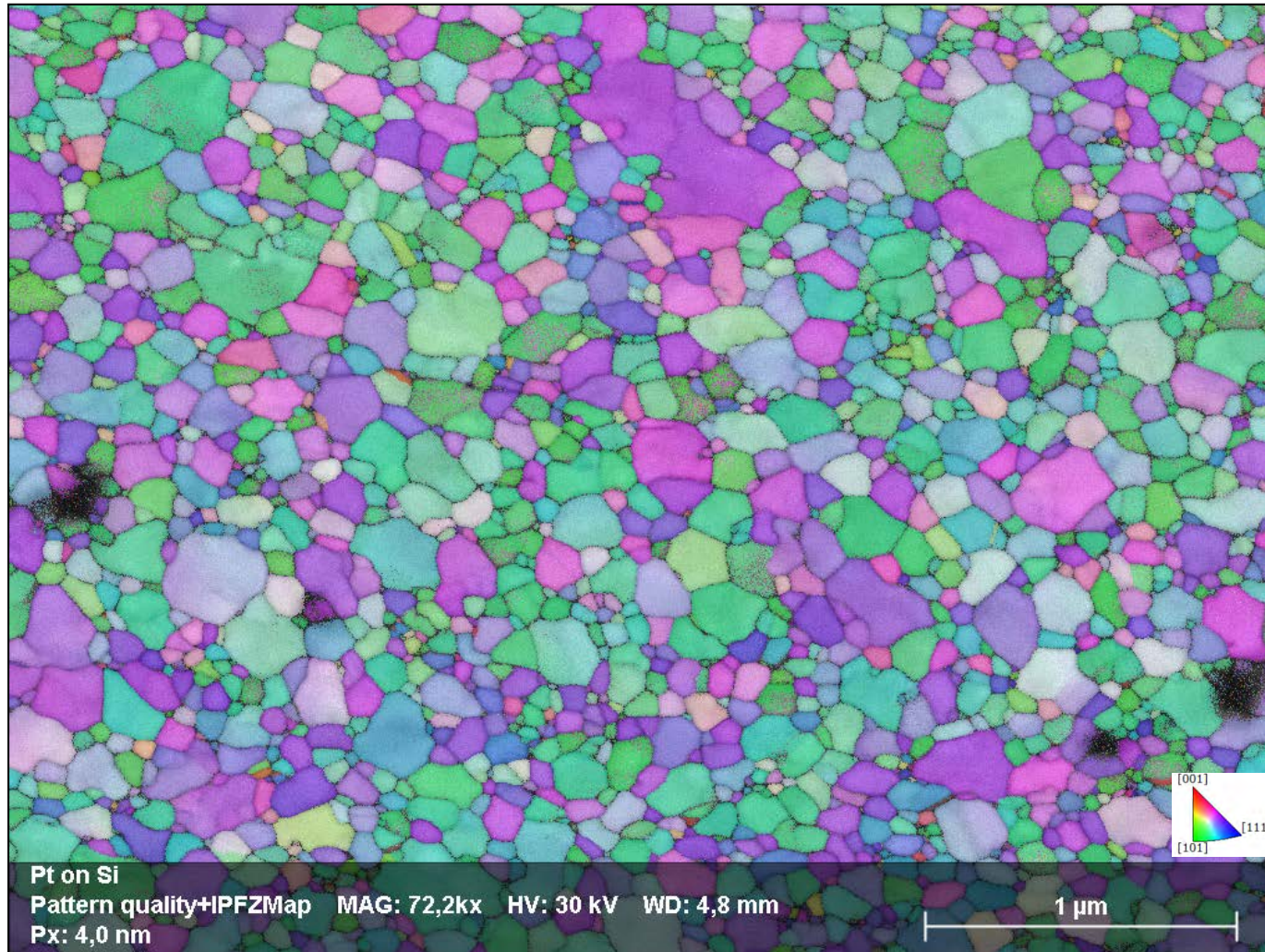
Step size: 4nm

Sample preparation: Wolfgang

Grünwald, Leica, Germany.

High speed TKD in SEM

higher spatial resolution, low probe current & speed



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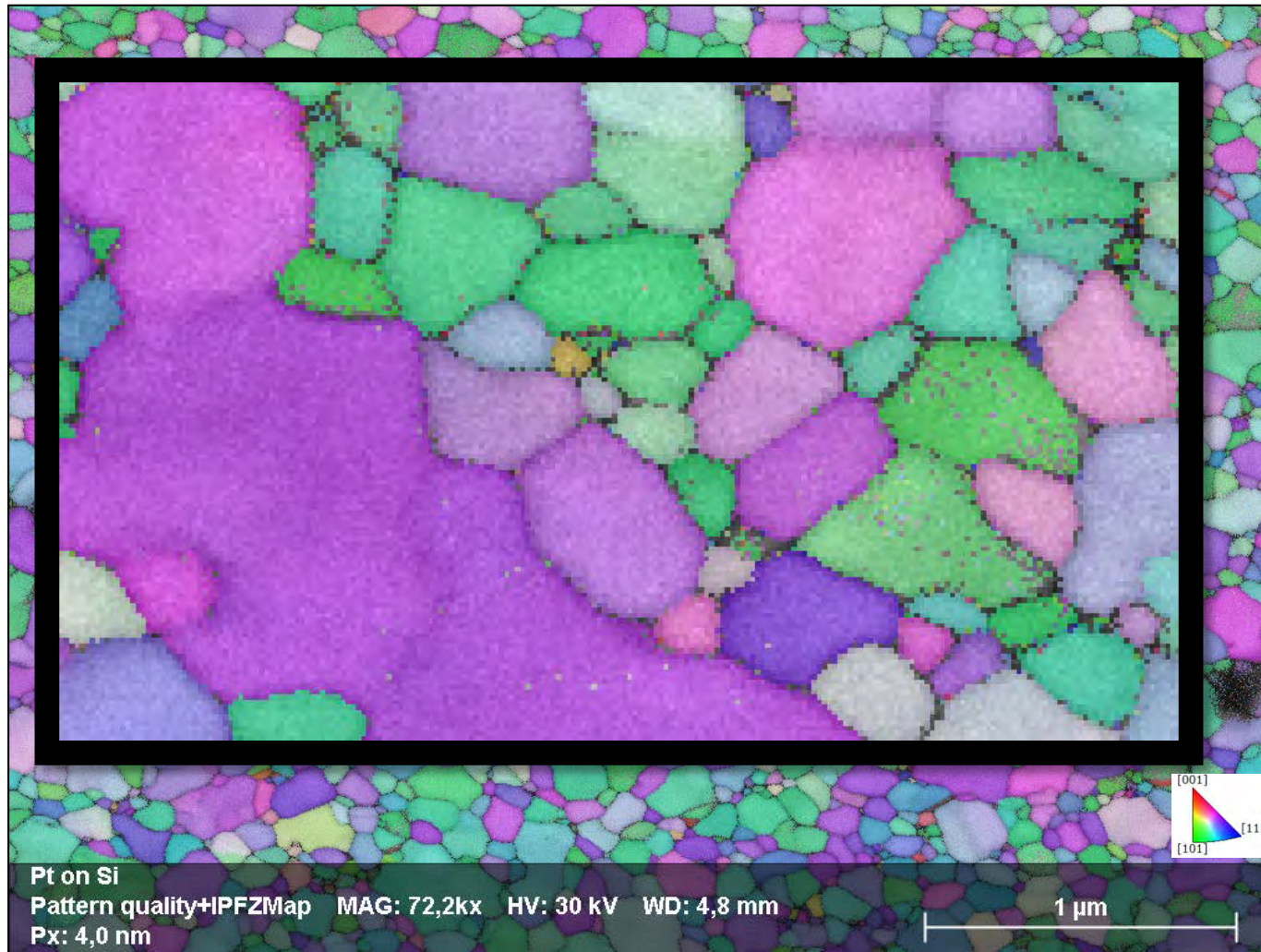
1260 grains

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Sample preparation: Wolfgang
Grünwald, Leica, Germany.

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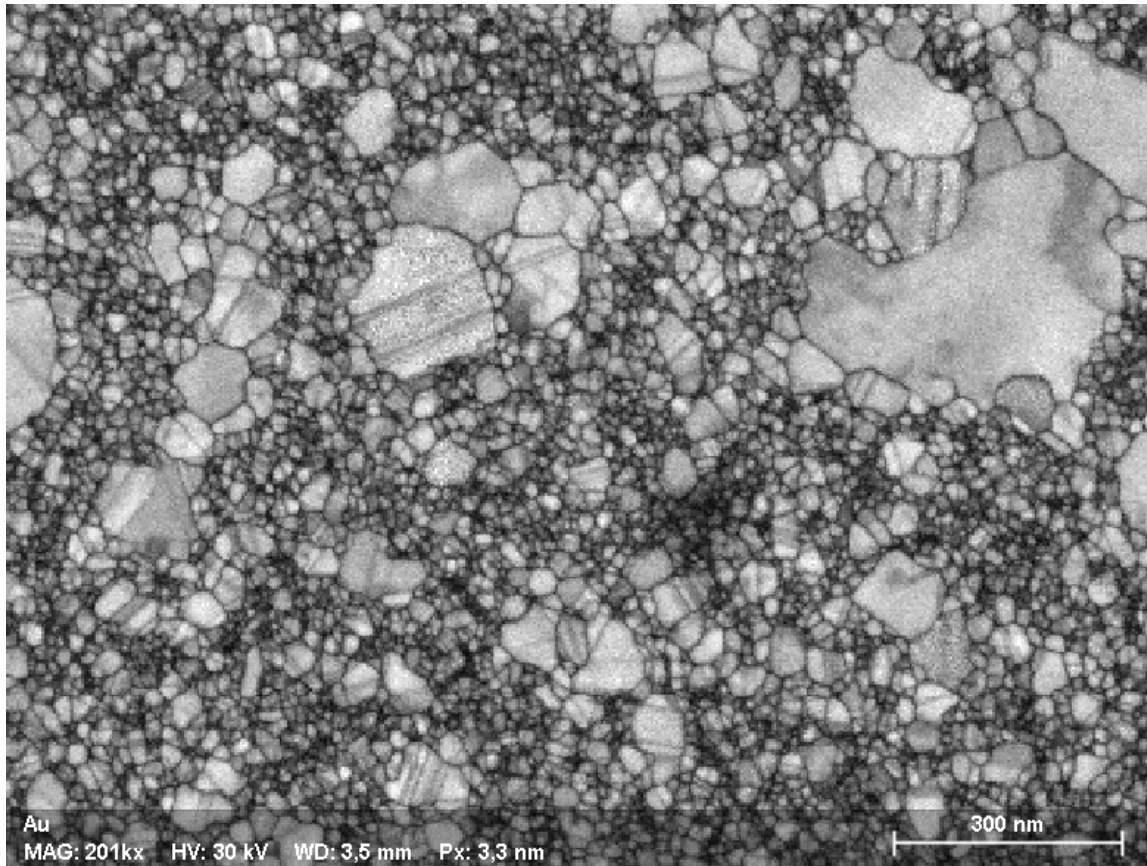
Grünwald, Leica, Germany.

High speed TKD in SEM

e-Flash^{FS} and OPTIMUS – resolution & speed



20nm Au film on 5nm Si₃N₄ membrane



Step size: 3.3nm

Acq. speed: 316 fps

Probe current : 1,8 nA

Total acquisition time: 08:22 min

Map size: 158,700 pixels

Pattern resolution: 160x120 pixels

Zero sol.: 12.5%

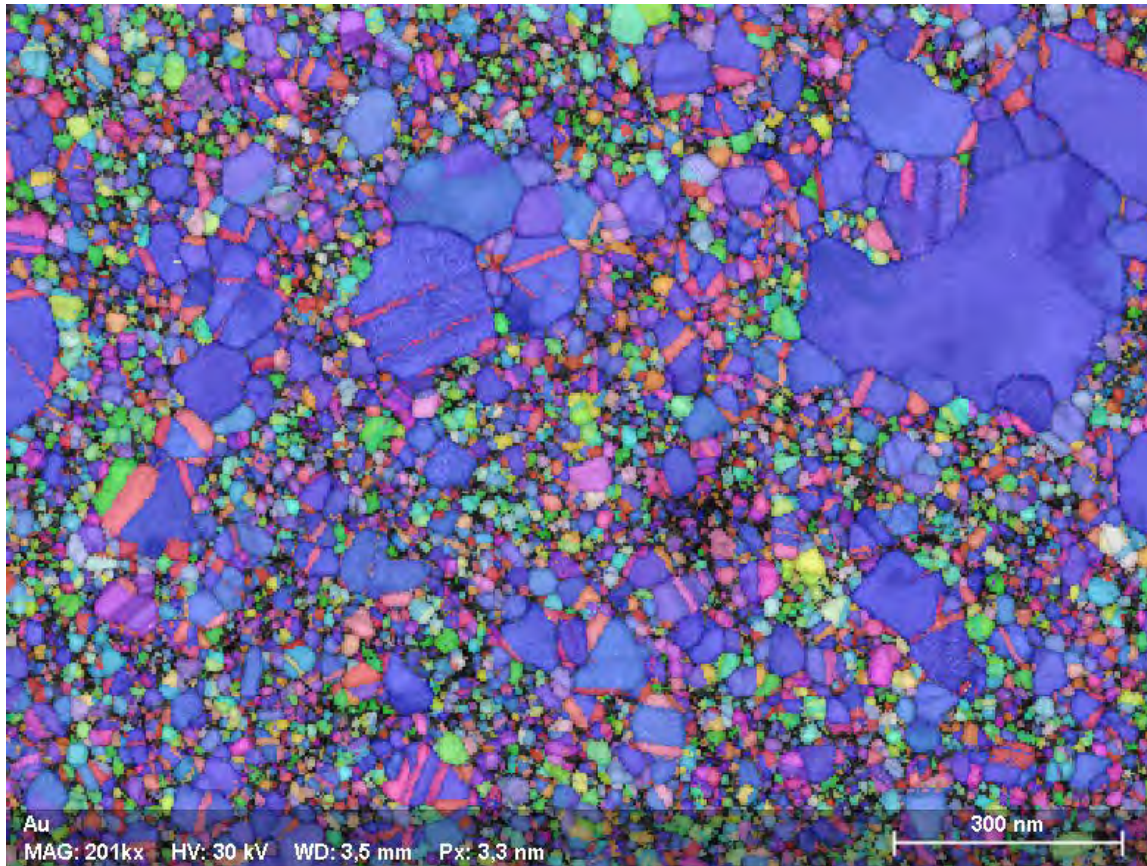
2662 grains

High speed TKD in SEM

e-Flash^{FS} and OPTIMUS – resolution & speed



20nm Au film on 5nm Si₃N₄ membrane



Step size: 3.3nm

Acq. speed: 316 fps

Probe current : 1,8 nA

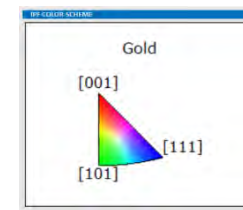
Total acquisition time: 08:22 min

Map size: 158,700 pixels

Pattern resolution: 160x120 pixels

Zero sol.: 12.5%

2662 grains

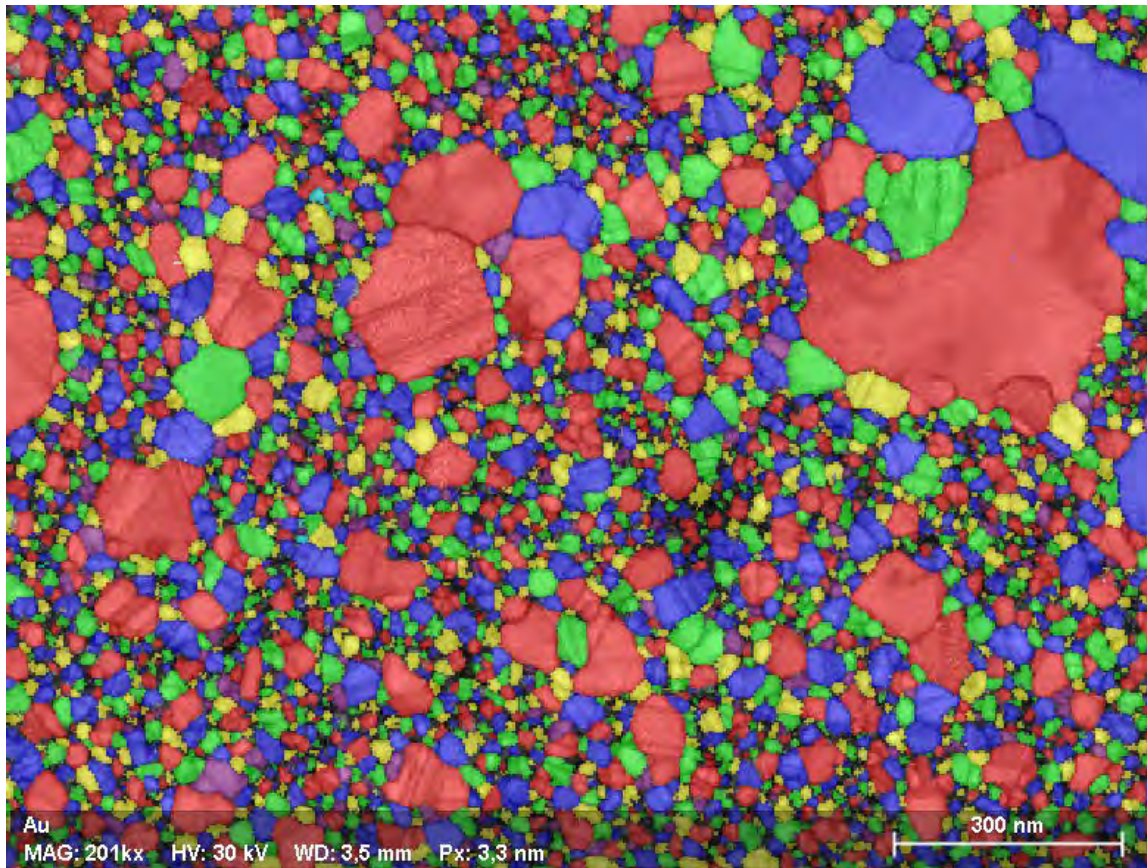


High speed TKD in SEM

e-Flash^{FS} and OPTIMUS – resolution & speed



20nm Au film on 5nm Si₃N₄ membrane



Step size: 3.3nm

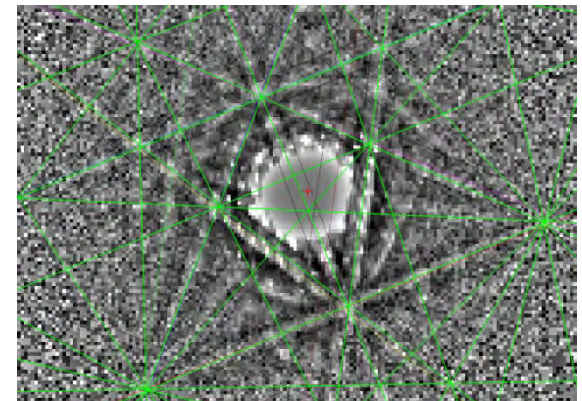
Acq. speed: 316 fps

Probe current : 1,8 nA

Total acquisition time: 08:22 min

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High speed TKD in SEM

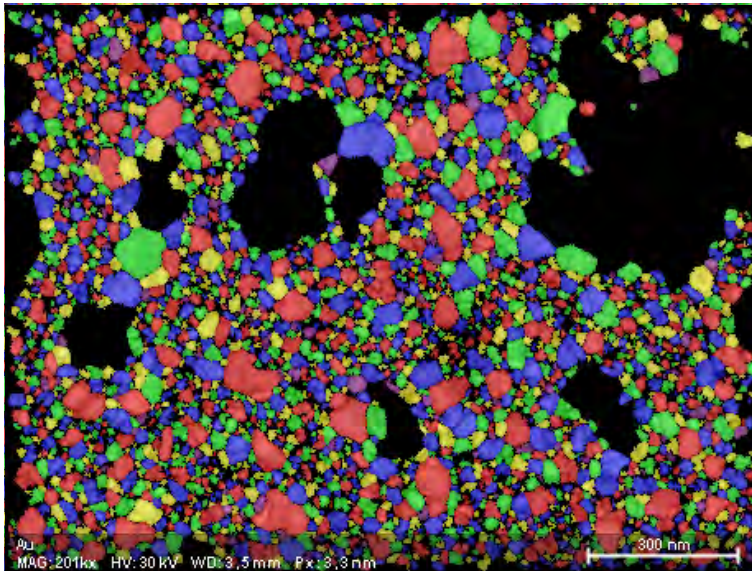
e-Flash^{FS} and OPTIMUS – resolution & speed



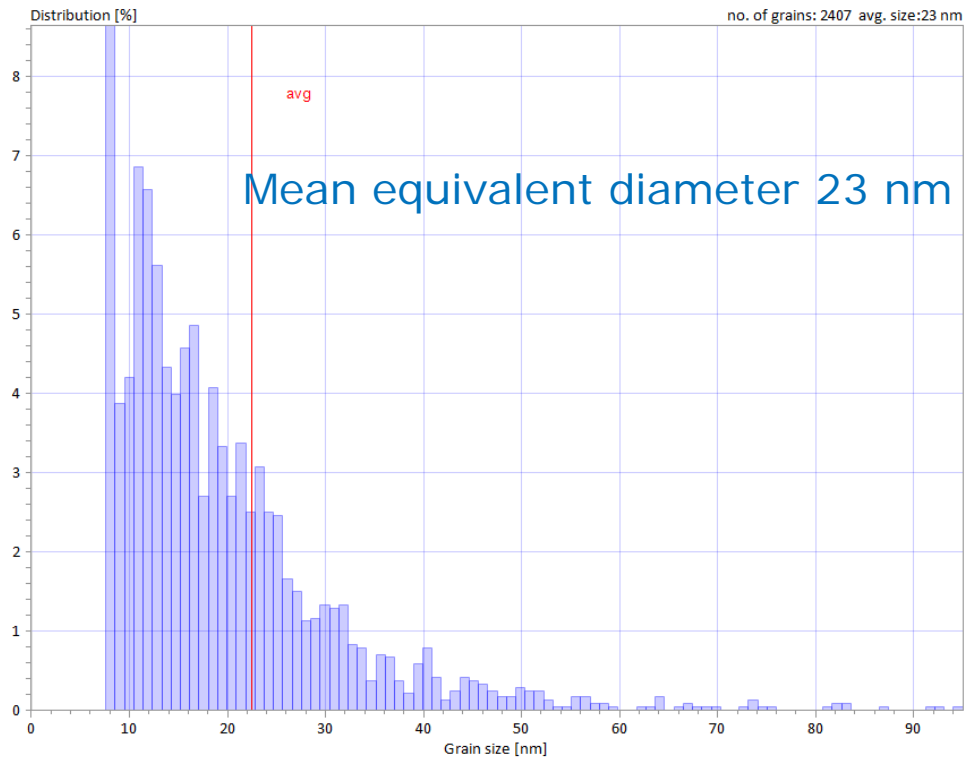
20nm Au film on 5nm Si₃N₄ membrane

2662 grains

2407 grains <100nm grain size



grain size distribution not weighted by area fraction :



High speed TKD in SEM

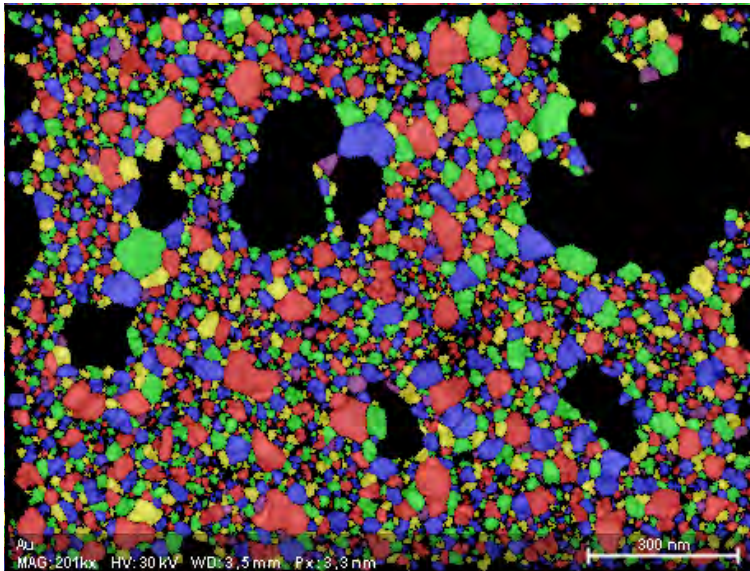
e-Flash^{FS} and OPTIMUS – resolution & speed



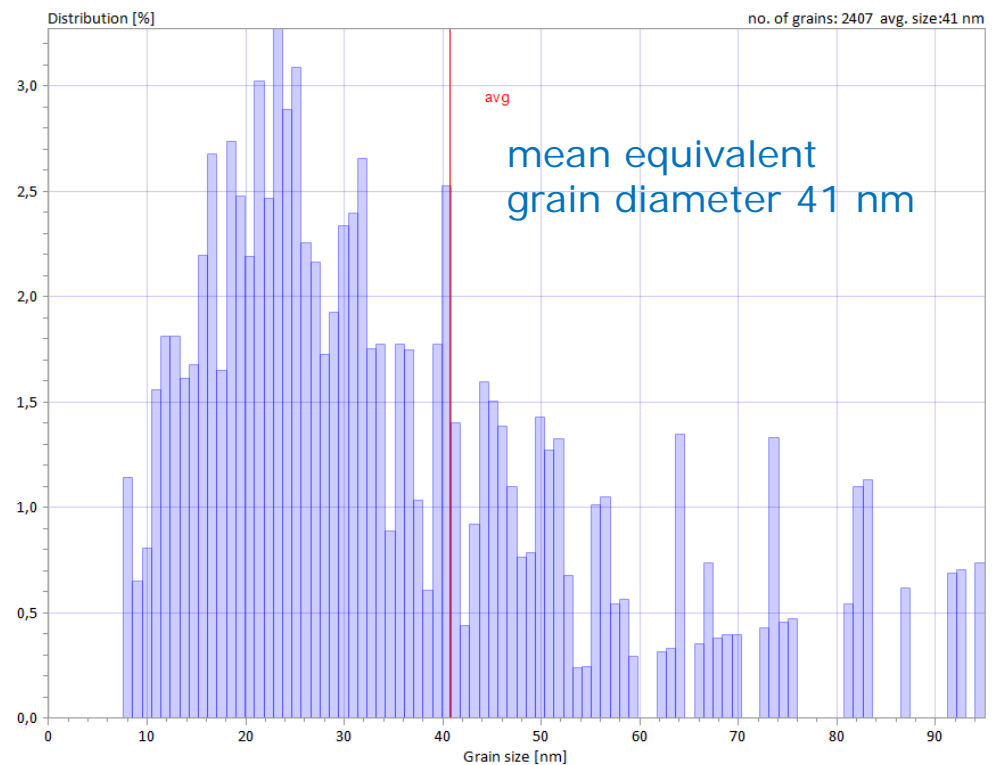
20nm Au film on 5nm Si₃N₄ membrane

2662 grains

2407 grains <100nm grain size



grain size distribution weighted by area fraction:

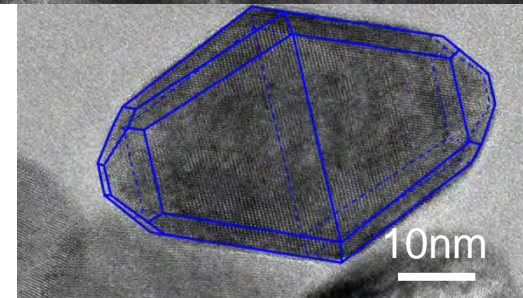
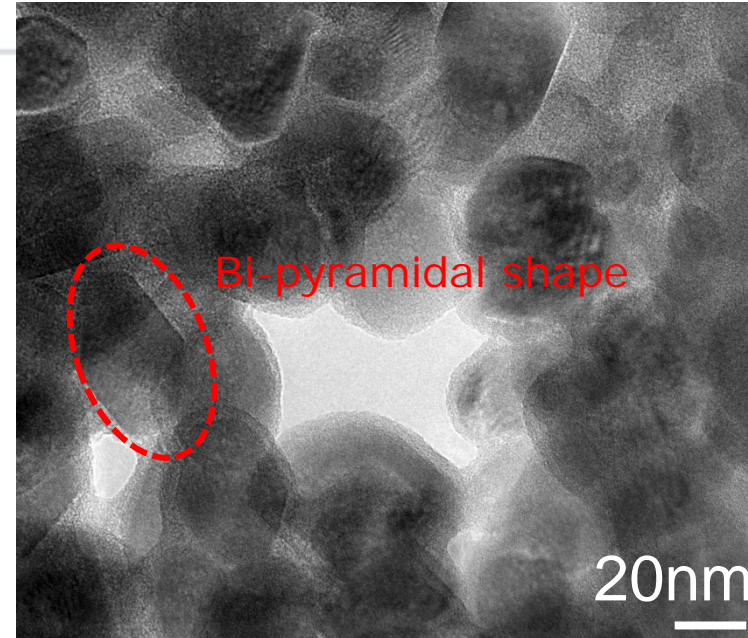
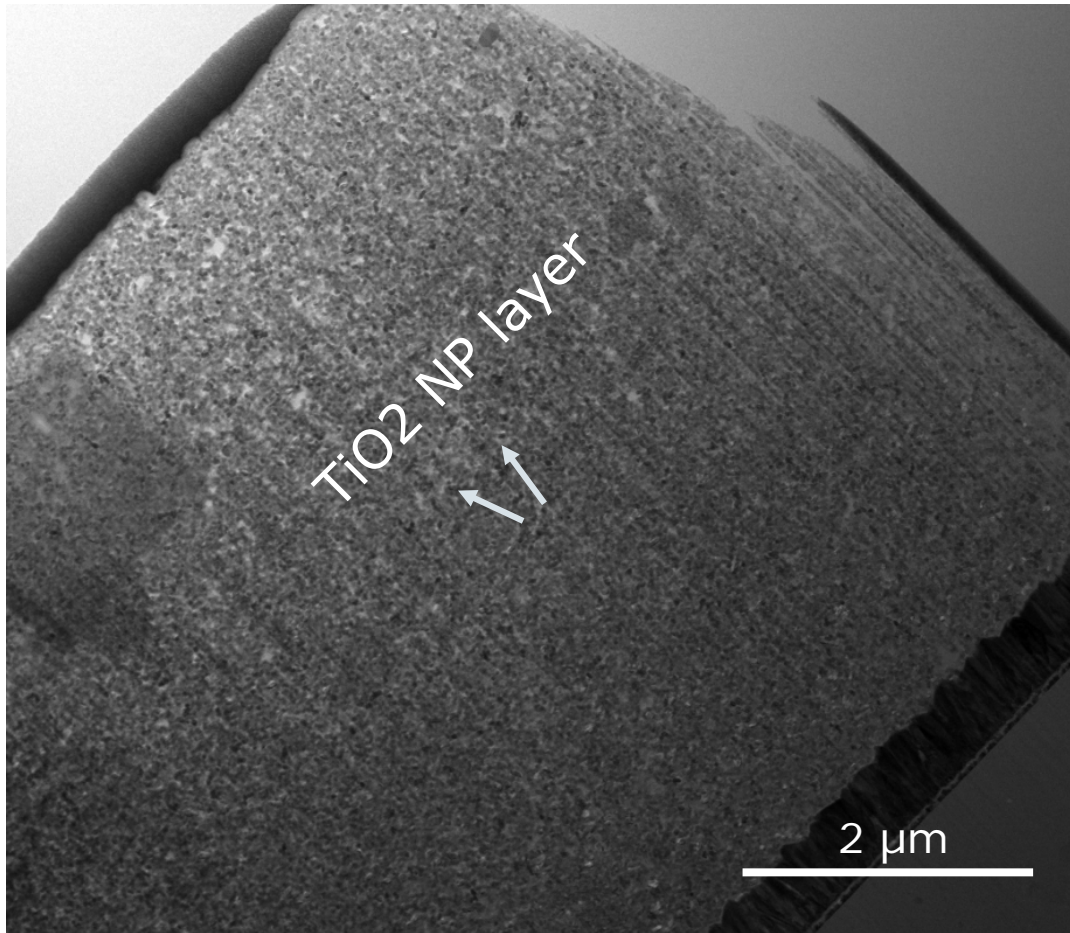


High speed TKD in SEM

characterisation of porous TiO_2 layer (DSSC)



SETNanoMetro project - Dye sensitized solar cells (DSSC)

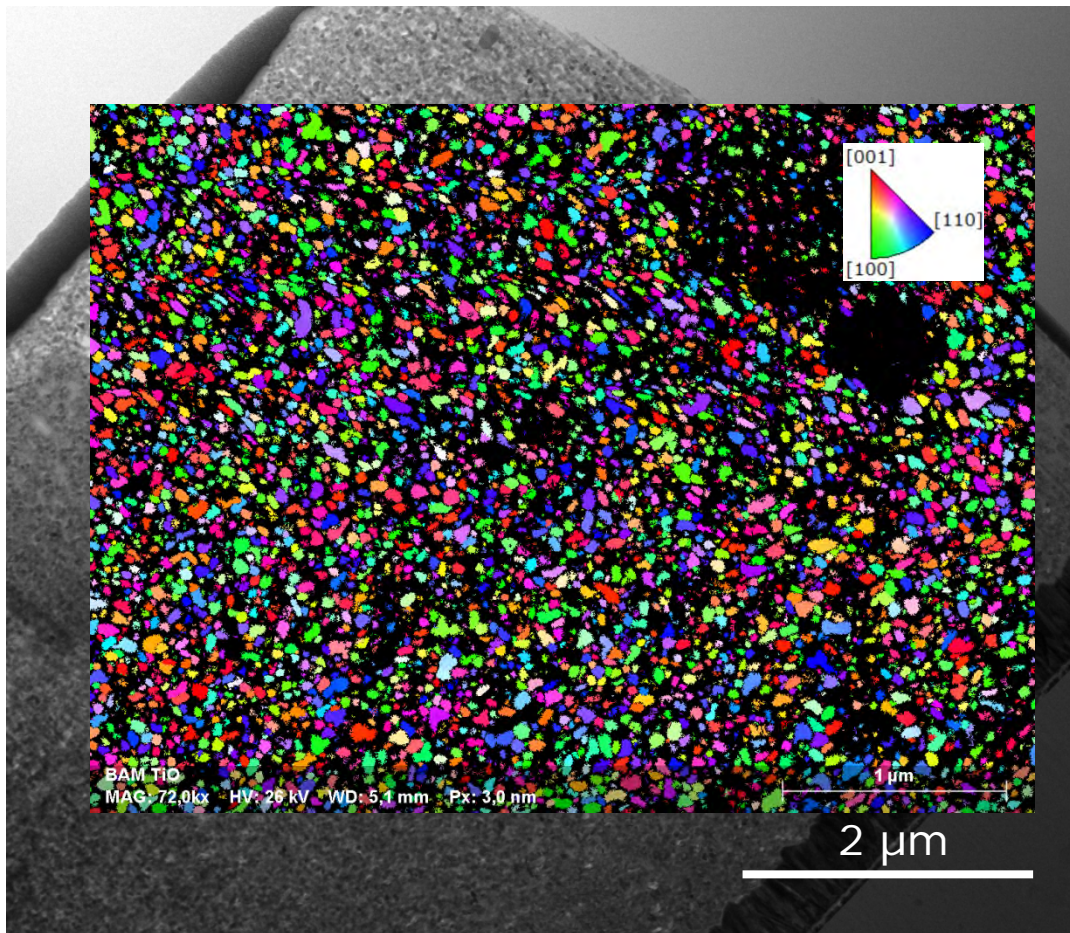


* In collaboration with Nicole Wollschläger
BAM, Berlin.
Sample preparation: FIB then Nanomill
(Fischione)

High speed TKD in SEM characterisation of porous TiO_2 layer (DSSC)



SETNanoMetro project - Dye sensitized solar cells (DSSC)



Indexed points: 58.1% (incl. pores)

Pattern resolution:

320x240 pixels

Speed: **243 fps**

Probe current : 7 nA

Map size: 1406*1055 pixels (~1,5M)

>6600 grains

Step size: 3 nm

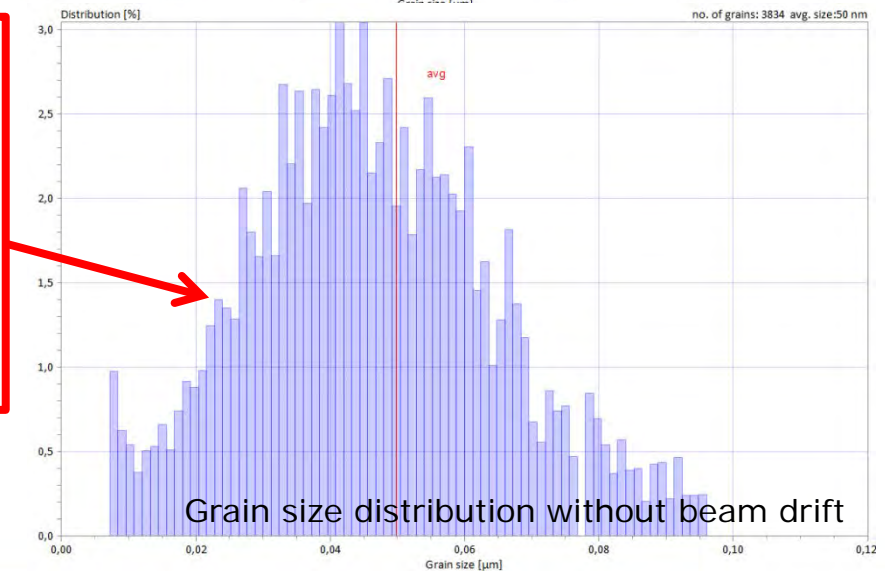
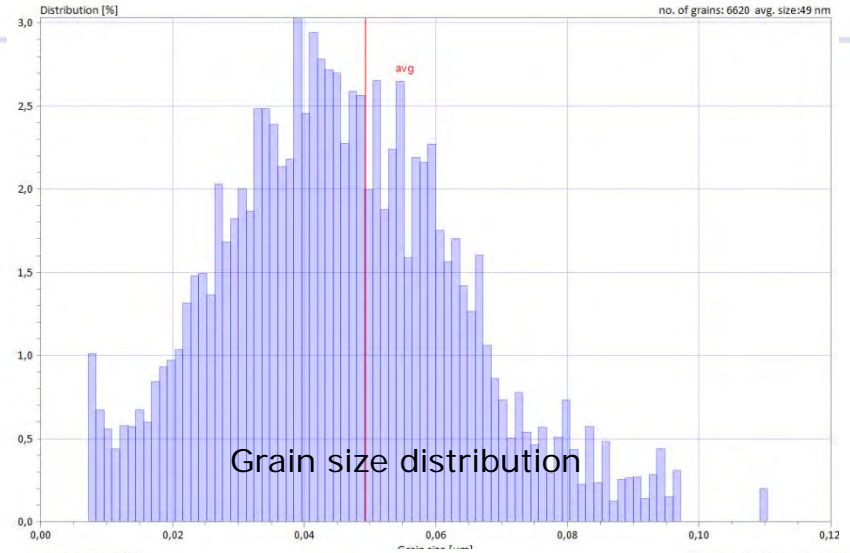
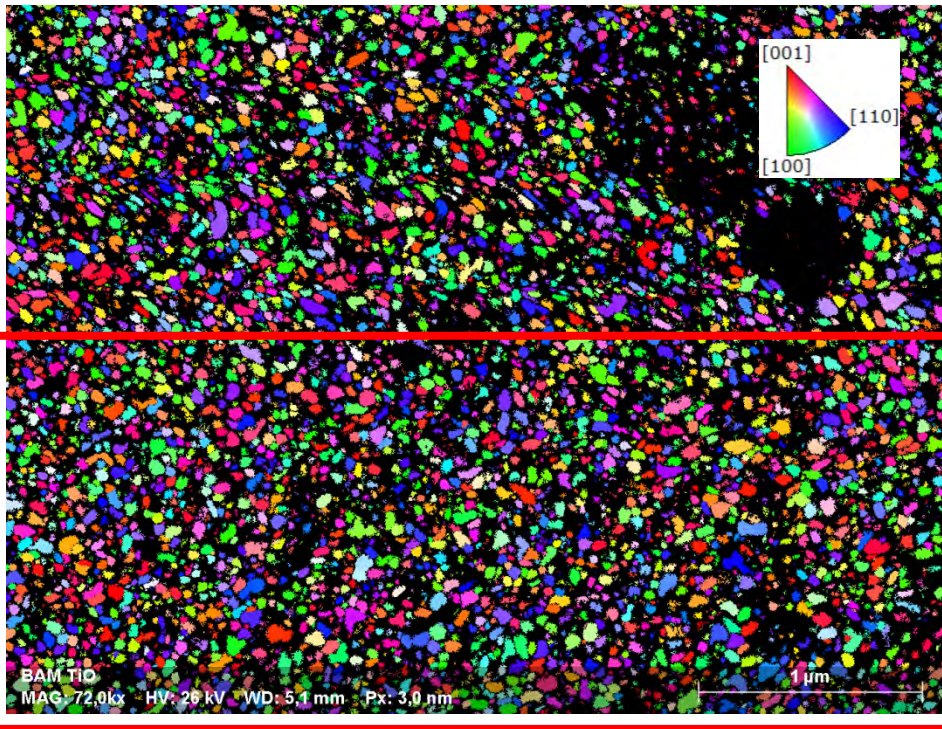
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High speed TKD in SEM characterisation of porous TiO_2 layer (DSSC)



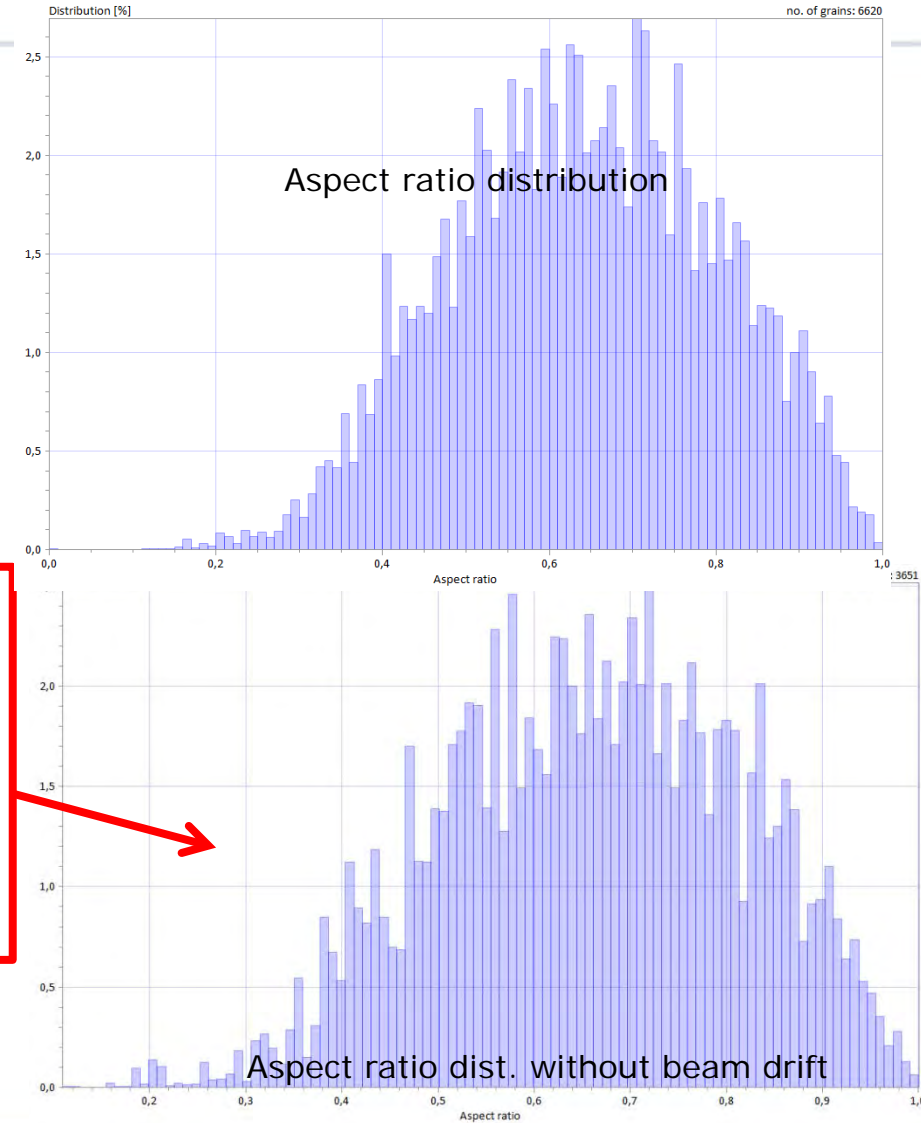
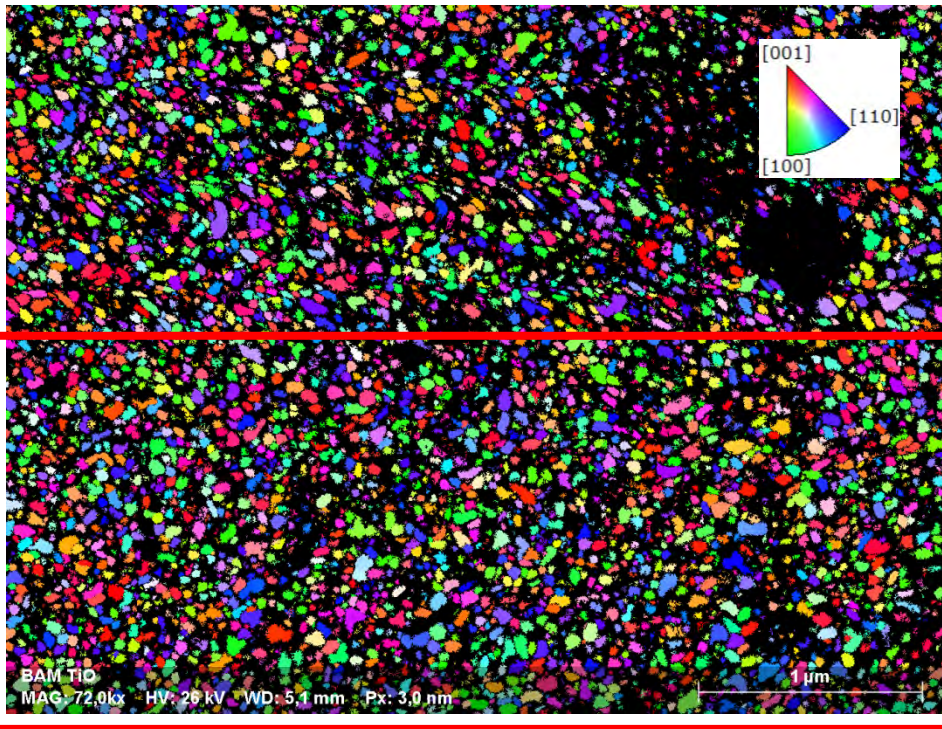
Grain size distribution



High speed TKD in SEM characterisation of porous TiO₂ layer (DSSC)



Grain size distribution



High speed TKD in SEM

characterisation of porous TiO₂ layer (DSSC)



	AFM	TEM	TSEM	TKD
Major axis (nm)	73.5	53	50	51
Minor axis (nm)	48.5	34	32	30
Aspect ratio	0.66	0.64	0.64	0.65

On-axis TKD :

- Fast: >1Mio. points in 1hour
- Reliable: providing analysis of statistical significance with > 5000 NPs measured in one map (FIB lamella)
- Practical: low contamination, sample can be further investigated

Materials Characterization [Volume 131](#), September 2017, Pages 39–48

"Characterization of the inner structure of porous TiO₂ nanoparticle films in dye sensitive solar cells (DSSC) by focused ion beam (FIB) tomography and transmission Kikuchi diffraction (TKD) in the scanning electron microscope (SEM)" Wollschläger et al., 2017

High speed TKD in SEM

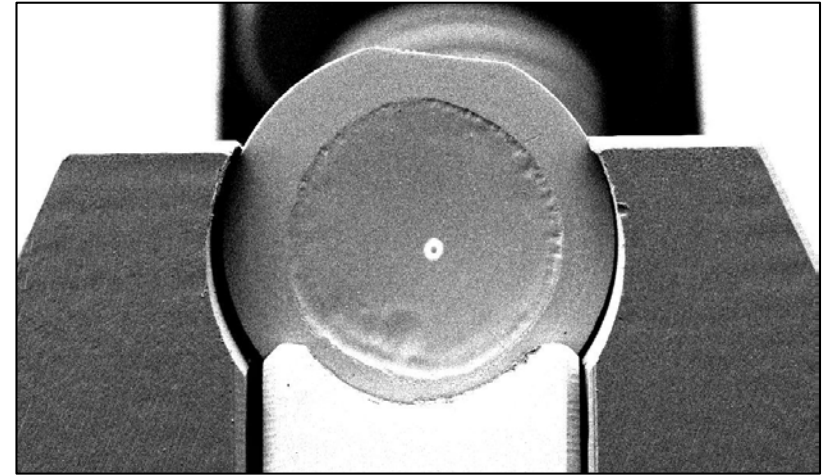
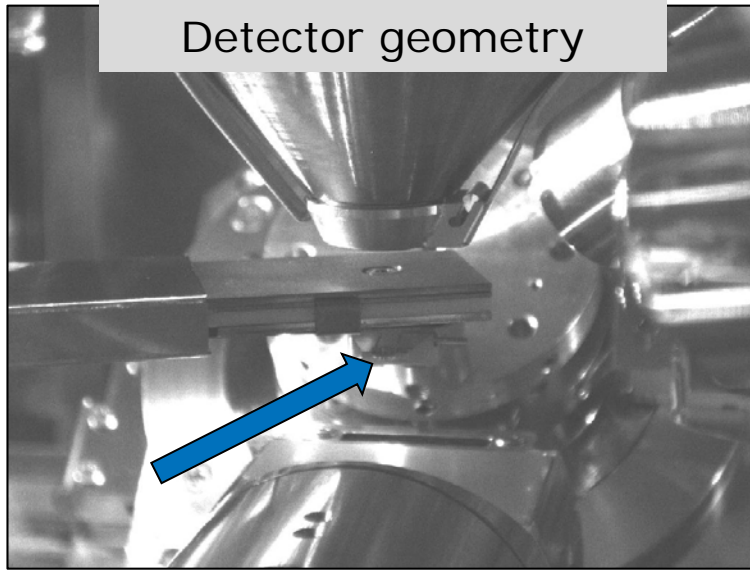
Summary



- Stronger signal
 - Faster measurements - up to 660fps
 - Use of low probe current for improved spatial resolution - $< 2\text{nm}$
- Minimum gnomonic distortions
 - Improved band detection and indexing quality
- Direct electron detection imaging (Si diodes) for Dark & Bright field images – $\sim 1\text{nm}$ resolution
- large area orientation mapping at nanometer resolution
- **Combined EDS/TKD measurement with FlatQuad**

Fast TKD/EDS simultaneous analysis

OPTIMUS TKD & XFlash FlatQuad



Fast simultaneous TKD/EDS measurements:

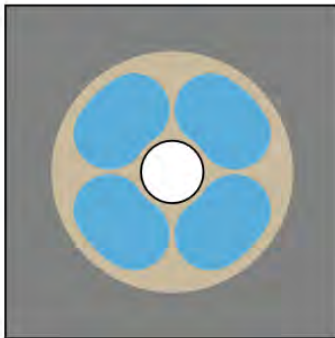
- e-Flash^{FS} EBSD™ detector retrofitted with OPTIMUS TKD™
- XFlash® FlatQuad
- Sample: ODS ferritic steel
- Bruker designed TKD sample holder

Fast TKD/EDS simultaneous analysis

XFlash FlatQuad



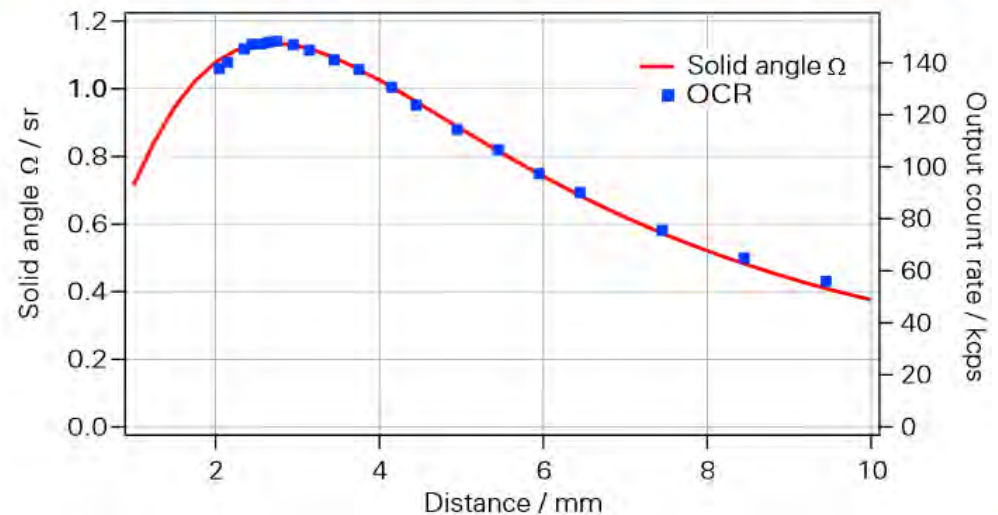
Detector layout



XFlash FlatQuad EDS detector:

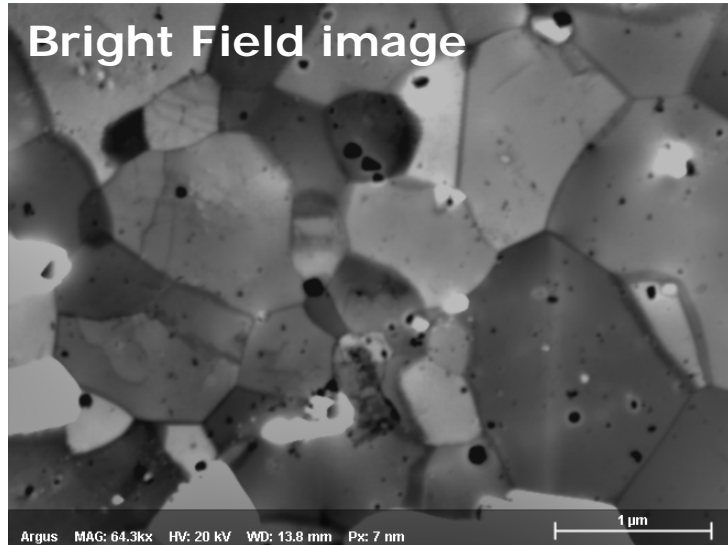
- $4 \times 15 \text{ mm}^2$
- Highest solid angle (up to 1 sr)
- High take-off angle $> 60^\circ$

Solid angle and OCR as a function of the detector-sample distance



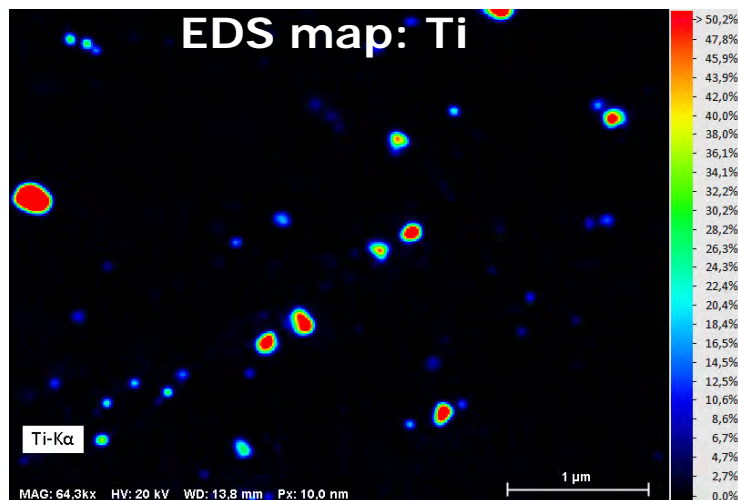
Fast TKD/EDS simultaneous analysis

OPTIMUS TKD & XFlash FlatQuad



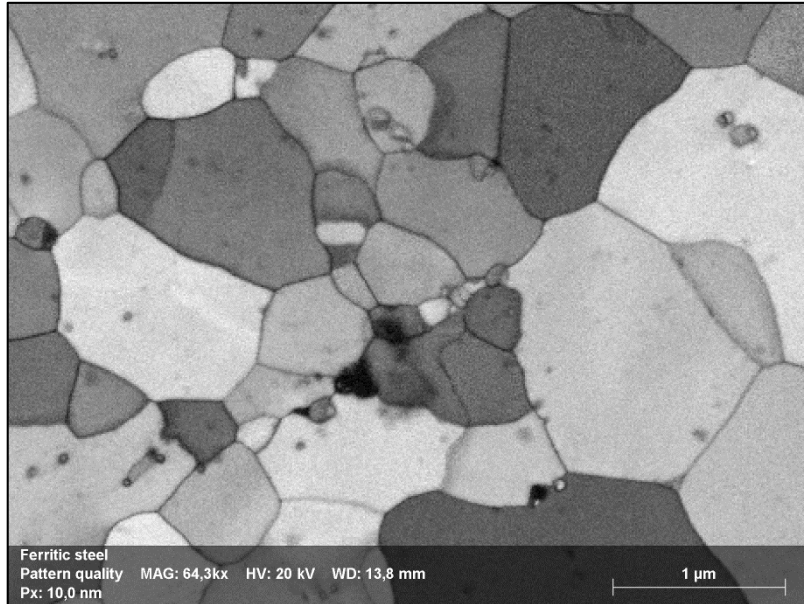
Key EDS parameters:

- Acquisition speed: 272 spectra/sec
- Probe current: 7nA
- Input count rate: ~1.5Mcps
- Dead time: 33%
- Output count rate: ~1Mcps
- Counts per spectrum: >3000



Super fast TKD/EDS measurements

OPTIMUS TKD & XFlash FlatQuad integration

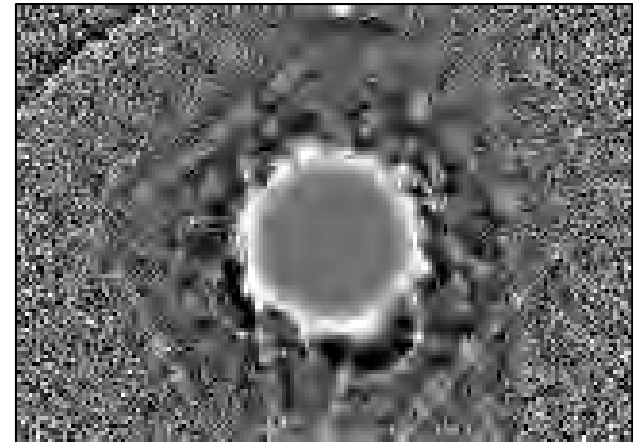
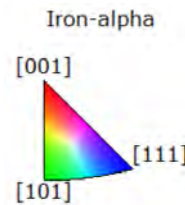
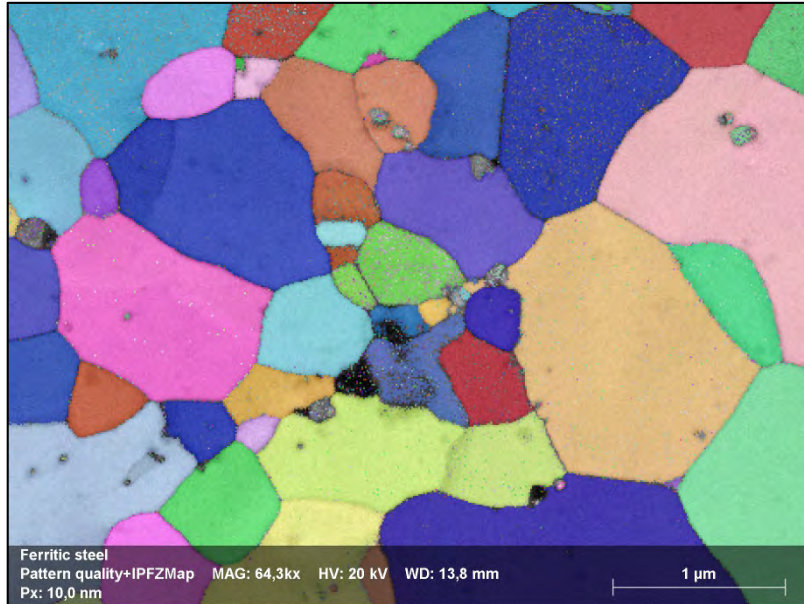


Offline phase ID and reanalysis:

- Speed with just reindexing: 10,000pps
- Reanalysis time: 18s
- Ferrite (red) and Ti₂O₃ (green)

Super fast TKD/EDS measurements

OPTIMUS TKD & XFlash FlatQuad integration

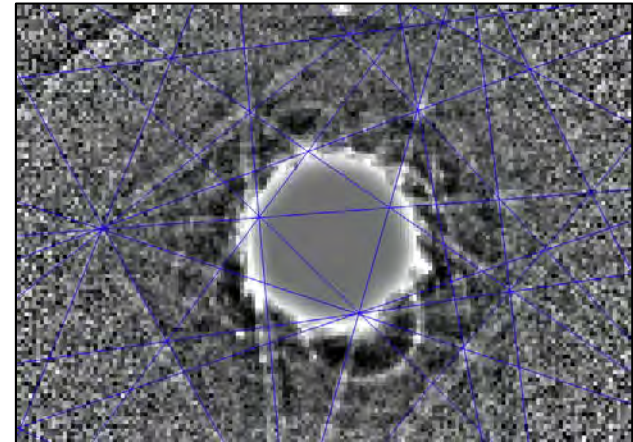
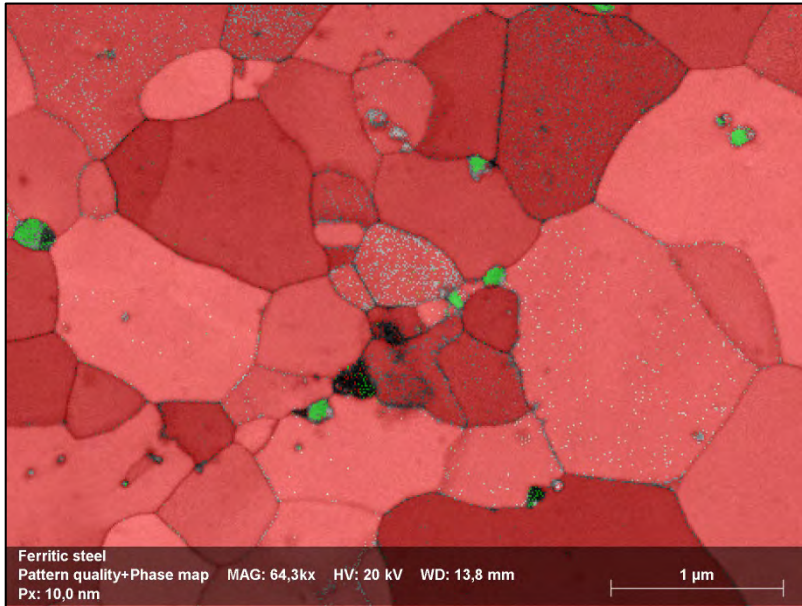


Offline phase ID and reanalysis:

- Speed with just reindexing: 10,000pps
- Reanalysis time: 18s
- Ferrite (red) and Ti_2O_3 (green)

Super fast TKD/EDS measurements

OPTIMUS TKD & XFlash FlatQuad integration

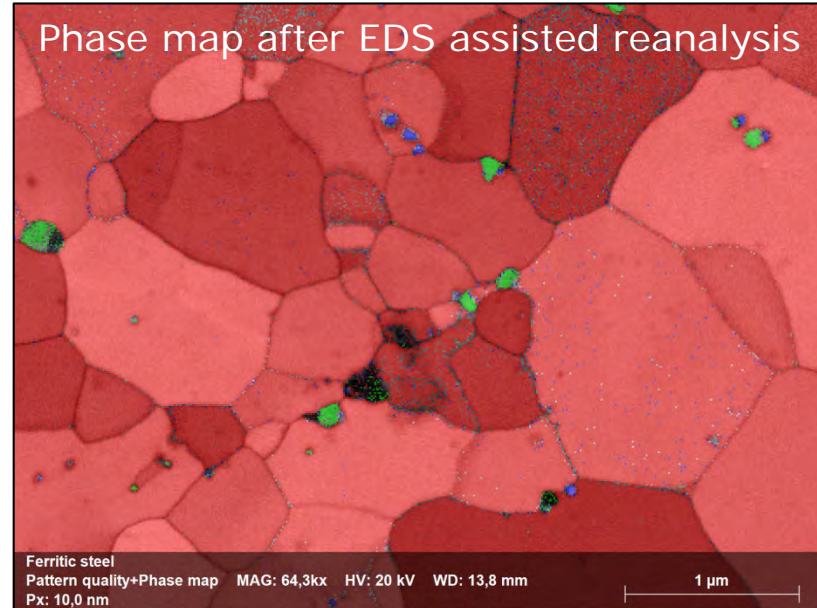
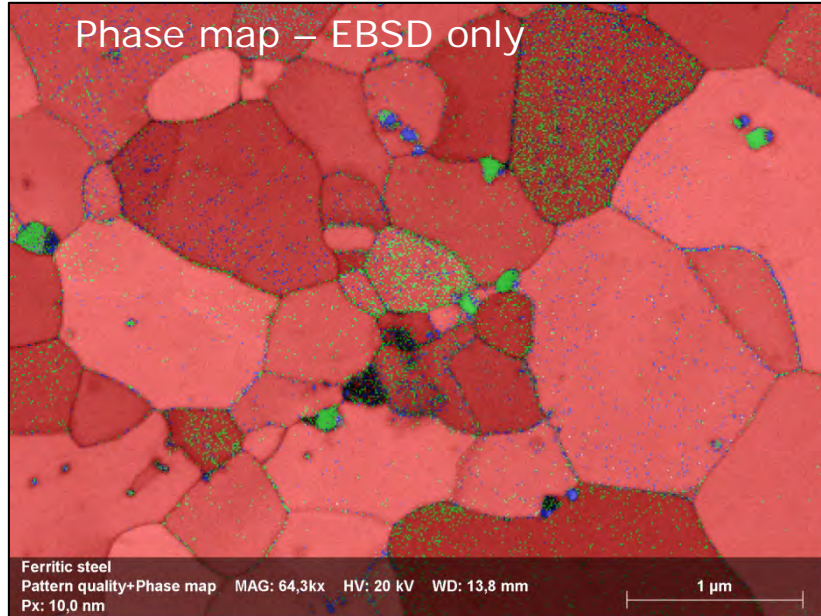


Offline phase ID and reanalysis:

- Speed with just reindexing: 10,000pps
- Reanalysis time: 18s
- Ferrite (red) and Ti₂O₃ (green)

Super fast TKD/EDS measurements

OPTIMUS TKD & XFlash FlatQuad integration



Offline phase ID and reanalysis :

- Speed of EDS assisted reanalysis: 500pps
- Reanalysis time: 5:28min
- Ferrite (red), Ti₂O₃ (green), Y₂(Ti_{0.993}Cr_{0.007})₂O₇ (blue)

Fast TKD/EDS simultaneous analysis

OPTIMUS TKD & XFlash FlatQuad



Summary:

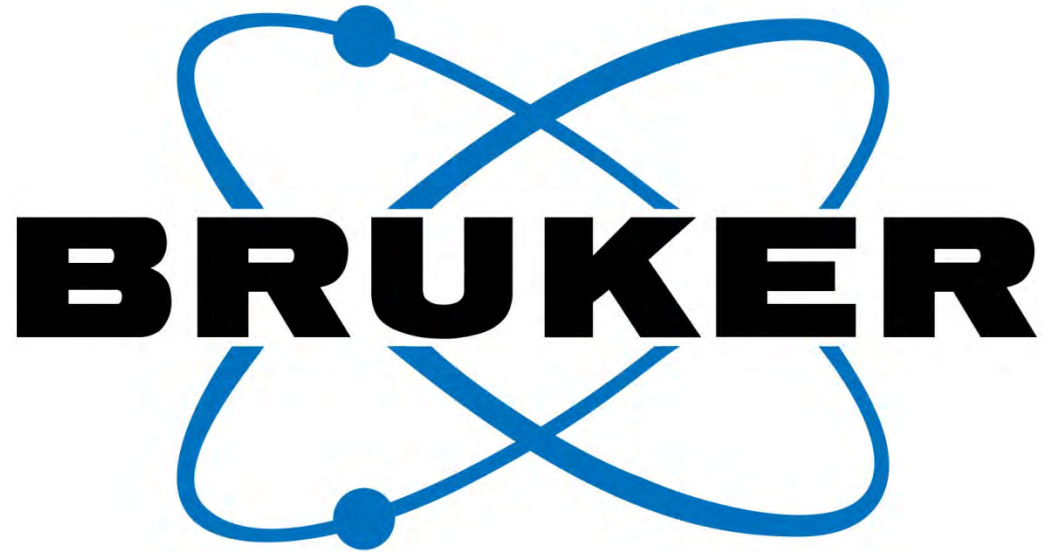
- Fast simultaneous TKD/EDS measurements
- Completion of map:
 - Offline phase ID
 - Offline super fast reindexing (reanalysis)
 - Offline fast EDS assisted reanalysis
- High efficiency and high quality data

Integration of two unique, high performance detectors!

Session is now open for questions

Please use the Q&A box to send us your questions.

(press: *send*)



Innovation with Integrity